

گروه فنی مهندسی جوش و برش مقدم

اعتماد از شما کیفیت و تخصص از ما



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مشهد خیام شمالی 63 خیابان پردیس 3

برای کسب اطلاعات بیشتر بر روی لینک ها کلیک کنید

- 7 سال سابقه آموزش تعمیرات تخصصی دستگاه های جوش اینورتری تک فاز و 3 فاز
- 7 سال سابقه فروش قطعات الكترونيكي دستگاه جوش
 تك فاز و 3 فاز
- آموزش تخصصی تحلیل دستگاه های جوش اینورتری مختص ابراز فروشان
 - آموزش تخصصی ابراز آلات شارژی

onsemi

IGBT - Field Stop600 V, 40

FGH40N60SFDTU, FGH40N60SFDTU-F085

Description

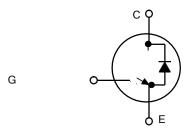
Using Novel Field Stop IGBT Technology, **onsemi**'s new series of Field Stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

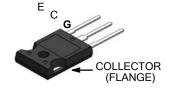
Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 \text{ V}$ @ $I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- Qualified to Automotive Requirements of AEC-Q101 (FGH40N60SFDTU-F085)
- These Devices are Pb-Free and are RoHS Compliant

Applications

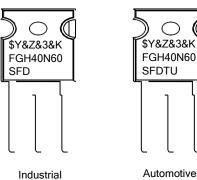
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS





TO-247-3LD CASE 340CK

MARKING DIAGRAM



 \$Y
 = onsemi Logo

 &Z
 = Assembly Plant Code

 &3
 = Numeric Date Code

 &K
 = Lot Code

FGH40N60SFD.

FGH40N60SFDTU = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Description	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage		V_{GES}	±20	V
Transient Gate-to-Emitter Voltage			±30	V
Collector Current	Tc = 25°C	Ic	80	Α
	Tc = 100°C		40	Α
Pulsed Collector Current	Tc = 25°C	I _{CM} (Note 1)	120	Α
Maximum Power Dissipation	Tc = 25°C	P _D 290		W
	Tc = 100°C		116	W
Operating Junction Temperature	TJ	-55 to +150	°C	
Storage Temperature Range	T _{stg}	-55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second	onds	TL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{θJC} (IGBT)	0.43	°C/W
Thermal Resistance, Junction-to-Case	R ₀ JC (Diode)	1.45	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FGH40N60SFDTU	FGH40N60SFD	TO-247	Tube	-	-	30
FGH40N60SFDTU-F085*	FGH40N60SFDTU	TO-247	Tube	-	-	30

^{*}Qualified to Automotive Requirements of AEC-Q101

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 250 μA	600	_	_	V
Temperature Coefficient of Breakdown Voltage	ΔBV _{CES} /ΔT _J	V _{GE} = 0 V, I _C = 250 μA	-	0.6	-	V/°C
Collector Cut-Off Current	I _{CES}	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μА
G-E Leakage Current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	I _C = 250 μA, V _{CE} = V _{GE}	4.0	4.7	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	2.3	2.9	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 125°C	-	2.5	-	V
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	1920	-	pF
Output Capacitance	C _{oes}		-	190	-	pF
Reverse Transfer Capacitance	C _{res}	1	_	65	-	pF

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	V _{CC} = 400 V, I _C = 40 A,	-	21	-	ns
Rise Time	tr	R_G = 10 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	-	35	-	ns
Turn-Off Delay Time	t _{d(off)}		-	138	-	ns
Fall Time	tf		-	18	54	ns
Turn-On Switching Loss	E _{on}		-	1.23	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.38	-	mJ
Total Switching Loss	E _{ts}	1 i	-	1.61	-	mJ
Turn-On Delay Time	t _{d(on)}	V _{CC} = 400 V, I _C = 40 A,	-	21	-	ns
Rise Time	t _r	R _G = 10 Ω, V_{GE} = 15 V, Inductive Load, T_{C} = 125°C	-	39	-	ns
Turn-Off Delay Time	t _{d(off)}		-	144	-	ns
Fall Time	t _f		-	48	-	ns
Turn-On Switching Loss	E _{on}		-	1.58	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.58	-	mJ
Total Switching Loss	E _{ts}	1	-	2.16	-	mJ
Total Gate Charge	Qg	V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	121	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	16	-	nC
Gate to Collector Charge	Q_{gc}]	-	68	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	1	Min	Тур	Max	Unit
Diode Forward Voltage	V_{FM}	I _F = 20 A	T _C = 25°C	-	1.80	2.6	V
			T _C = 125°C	-	1.70	-	
Diode Reverse Recovery Time	t _{rr}	$I_F = 20 \text{ A}, di_F/dt = 200 \text{ A}/\mu\text{s}$	T _C = 25°C	-	68	-	ns
			T _C = 125°C	-	240	-	
Diode Reverse Recovery Charge	Q _{rr}		T _C = 25°C	-	160	-	nC
			T _C = 125°C	-	840	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

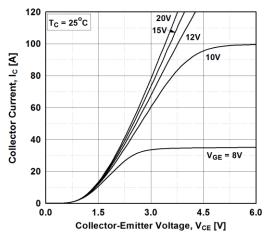


Figure 1. Typical Output Characteristics

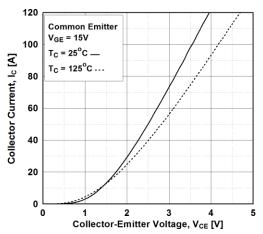


Figure 3. Typical Saturation Voltage Characteristics

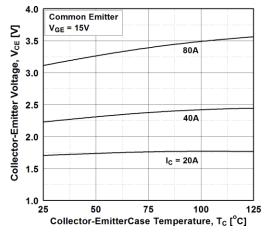


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

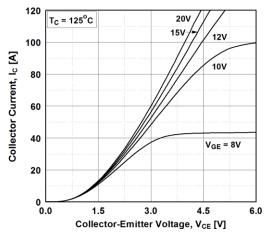


Figure 2. Typical Output Characteristics

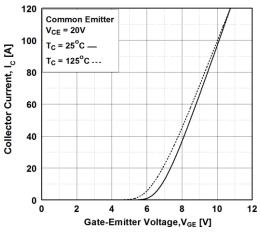


Figure 4. Transfer Characteristics

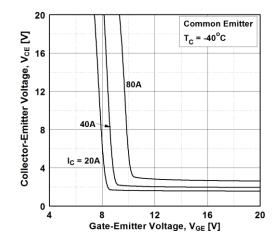


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

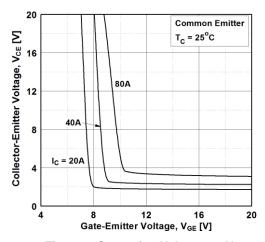


Figure 7. Saturation Voltage vs. V_{GE}

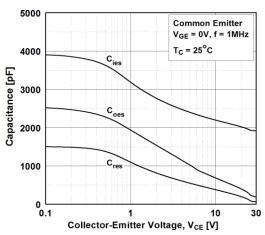


Figure 9. Capacitance Characteristics

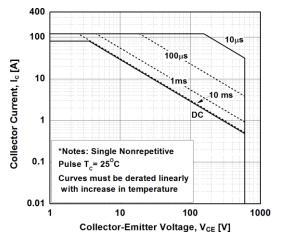


Figure 11. SOA Characteristics

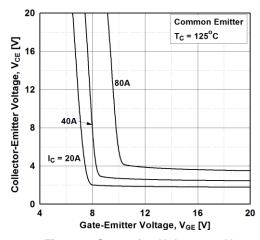


Figure 8. Saturation Voltage vs. V_{GE}

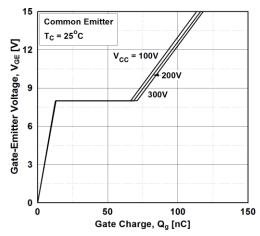


Figure 10. Gate Charge Characteristics

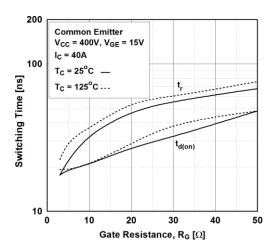


Figure 12. Turn-on Characteristics vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

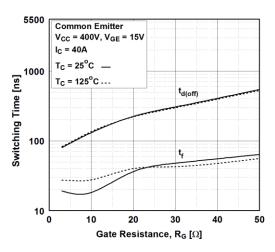


Figure 13. Turn-Off Characteristics vs. Gate Resistance

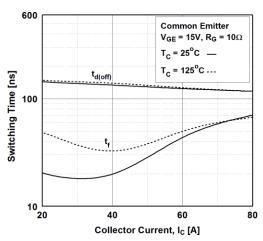


Figure 15. Turn-Off Characteristics vs. Collector Current

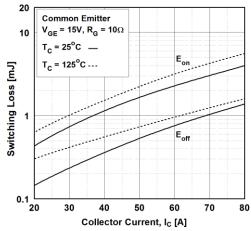


Figure 17. Switching Loss vs. Collector Current

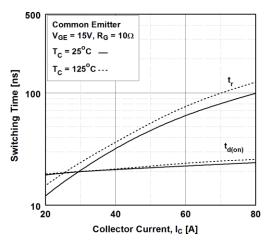


Figure 14. Turn-On Characteristics vs. Collector Current

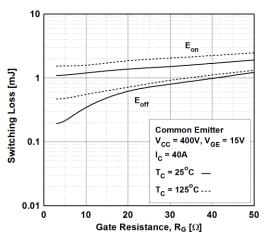


Figure 16. Switching Loss vs. Gate Resistance

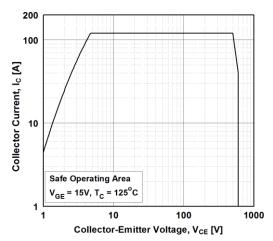


Figure 18. Turn-Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

200

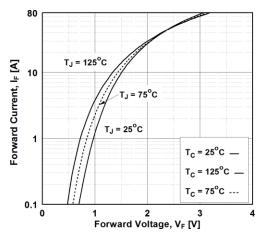


Figure 19. Forward Characteristics

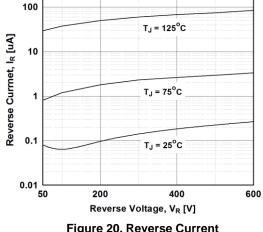


Figure 20. Reverse Current

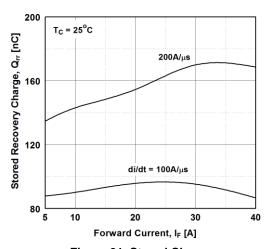


Figure 21. Stored Charge

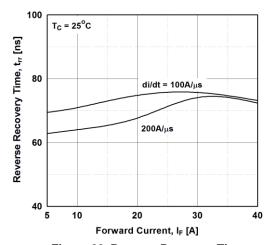


Figure 22. Reverse Recovery Time

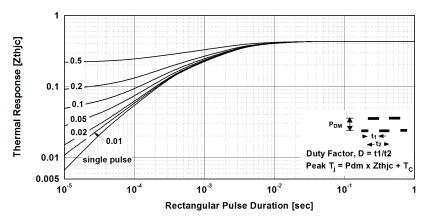
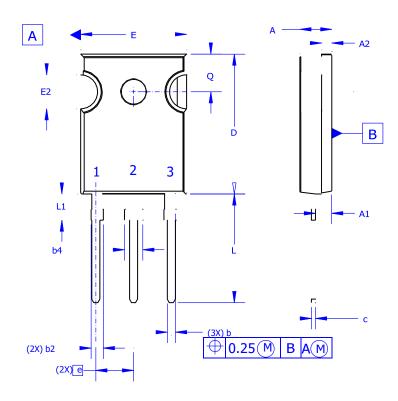


Figure 23. Transient Thermal Impedance of IGBT



TO-247-3LD SHORT LEAD CASE 340CK ISSUE A

DATE 31 JAN 2019





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code A

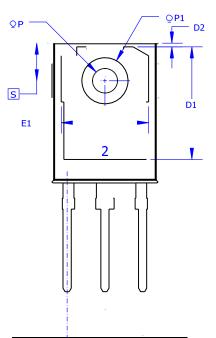
= Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MII	LIMET	ERS
MITO	MIN	NOM	MAX
Α	4.58	4.70	4.82
A 1	2.20	2.40	2.60
A2	1.40	1.50	1.60
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
C	0.51	0.61	0.71
D	20.32	20.57	20.82
D1	13.08	>	2
D2	0.51	0.93	1.35
Е	15.37	15.62	15.87
E1	12.81	>	2
E2	4.96	5.08	5.20
е	2	5.56	2
L	15.75	16.00	16.25
L1	3.69	3.81	3.93
Ø₽	3.51	3.58	3.65
Ø P 1	6.60	6.80	7.00
Q	5.34	5.46	5.58
S	5.34	5.46	5.58

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DESCRIPTION:	TO-247-3LD SHORT LEAD	D	PAGE 1 OF 1	

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